



Pb-free
HEAT



AN5307B

Through-hole IRED/ ϕ 5 Type

Features

Package	ϕ 5 type, Water clear epoxy
Product features	<ul style="list-style-type: none">• Wide Distribution• Lead-free soldering compatible• RoHS compliant
Peak Wavelength	940nm
Half Intensity Angle	38 deg.
Die materials	GaAs
Rank grouping parameter	Sorted by radiant intensity per rank taping
Soldering methods	TTW (Through The Wave) soldering and manual soldering ※Please refer to Soldering Conditions about soldering.
ESD	2kV (HBM)
Packing	Bulk : 200pcs(MIN.)

Recommended Applications

Electric Household Appliances, OA/FA, PC/Peripheral Equipment, Other General Applications

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings	Unit
Power Dissipation	Pd	160	mW
Forward Current	I _F	100	mA
Pulse Forward Current ※1	I _{FRM}	1,000	mA
Derating (Ta=25°C or higher)	ΔI _F	1.33	mA/°C
	ΔI _{FRM}	13.3	mA/°C
Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-30~+85	°C
Storage Temperature	T _{stg}	-30~+100	°C

 ※1 I_{FRM} Measurement condition : Pulse Width ≤ 0.1ms, Duty ≤ 1/100

Electro-Optical Characteristics

(Ta=25°C)

Item	Conditions	Symbol	Characteristics		Unit
			MIN.	TYP.	
Forward Voltage	I _F =50mA	V _F	MIN.	1.15	V
			TYP.	1.3	
			MAX.	1.45	
Reverse Current	V _R =5V	I _R	MAX.	10	μA
Radiant Intensity	I _F =50mA	I _E	MIN.	8.4	mW/sr
			TYP.	19	
Total Output Power	I _F =50mA	P _o	TYP.	17	mW
Peak Wavelength	I _F =50mA	λ _p	TYP.	940	nm
Spectral Half-width	I _F =50mA	Δλ	TYP.	50	nm
Half Intensity Angle	I _F =50mA	2θ _{1/2}	TYP.	38	deg.
Response Time	I _F =50mA	tr/tf	TYP.	1/1	μs

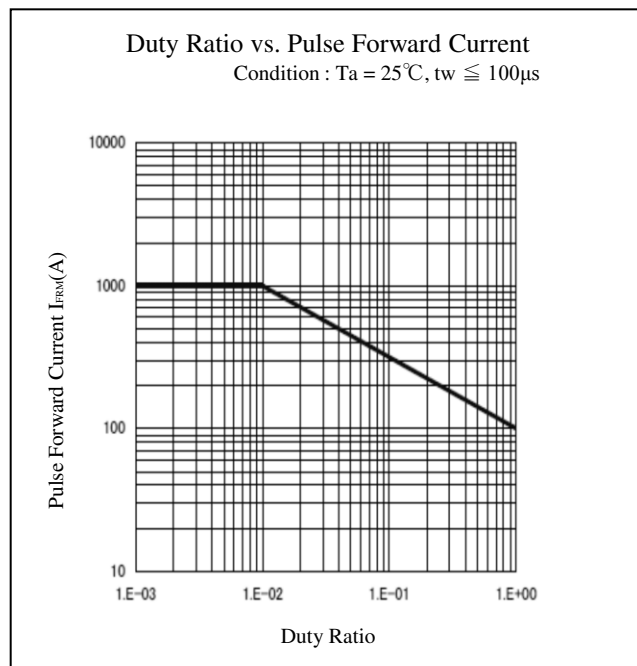
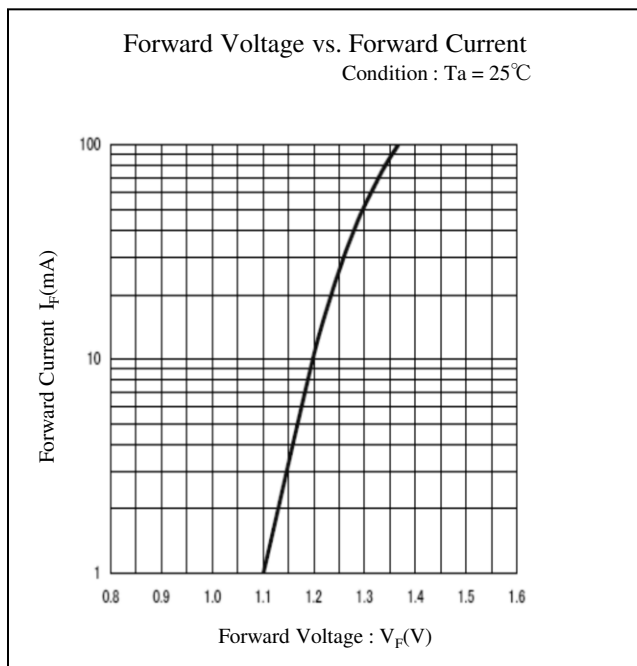
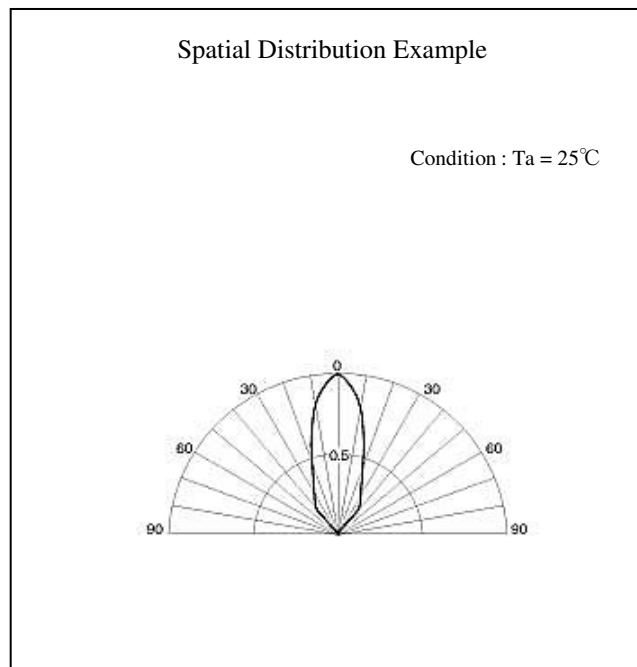
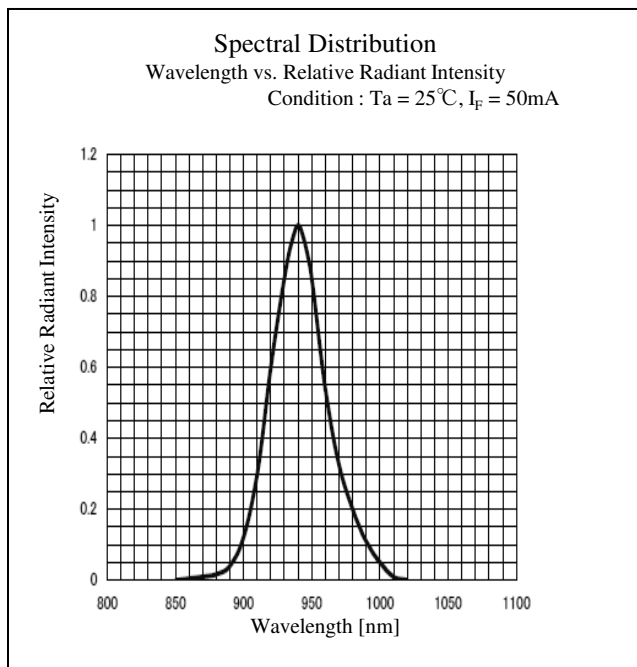
Radiant Intensity Rank

(Ta=25°C)

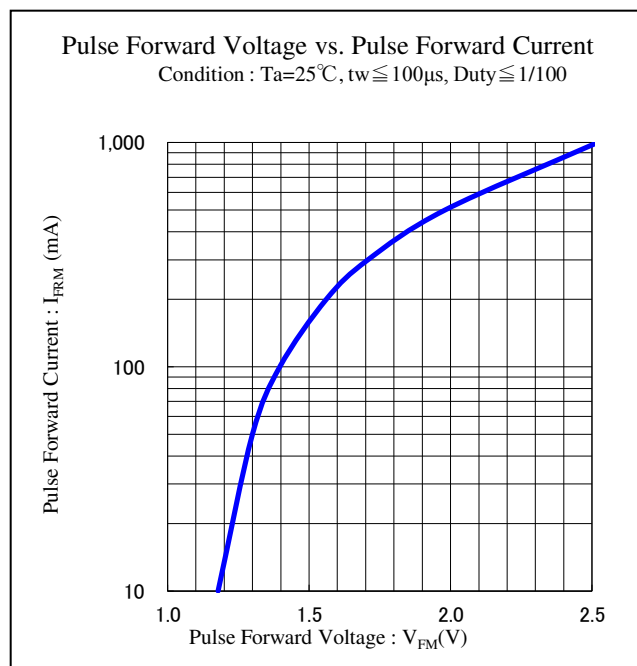
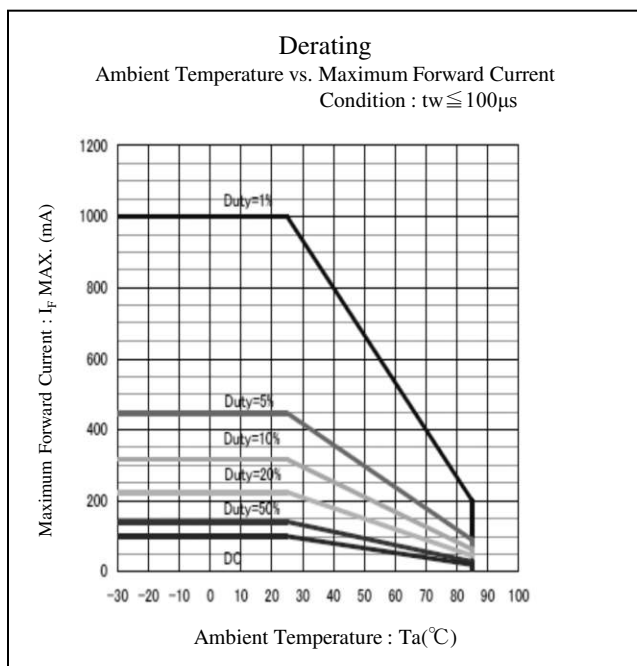
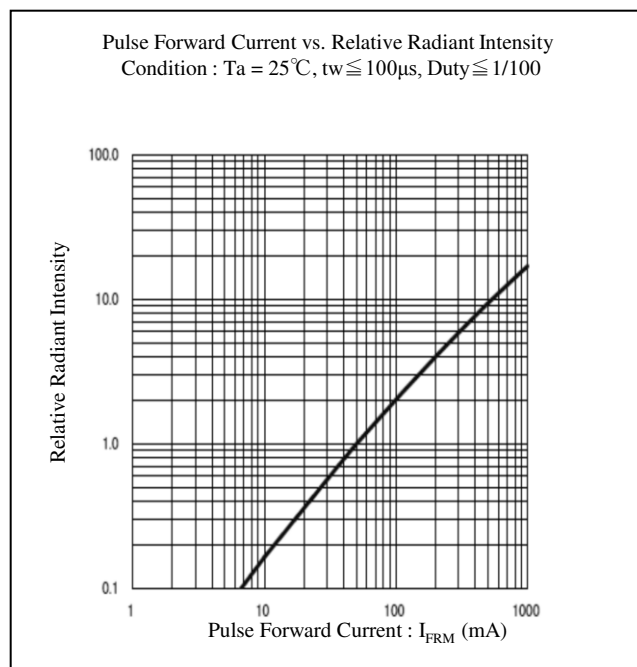
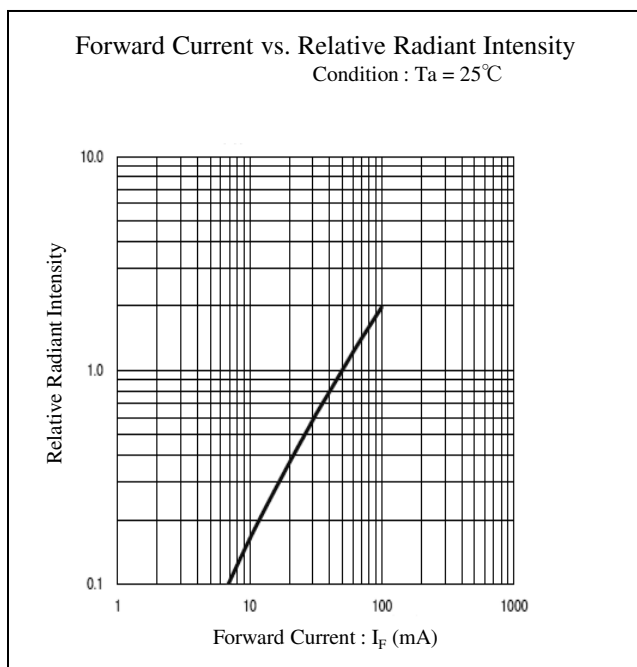
Rank	I _E (mW/sr)		Condition
	MIN.	MAX.	
A	8.4	16.8	I_F = 50mA
B	12.0	24.0	
C	16.8	33.6	
D	24.0	48.0	
E	33.6	67.2	

※Please contact our sales staff concerning rank designation.

Technical Data

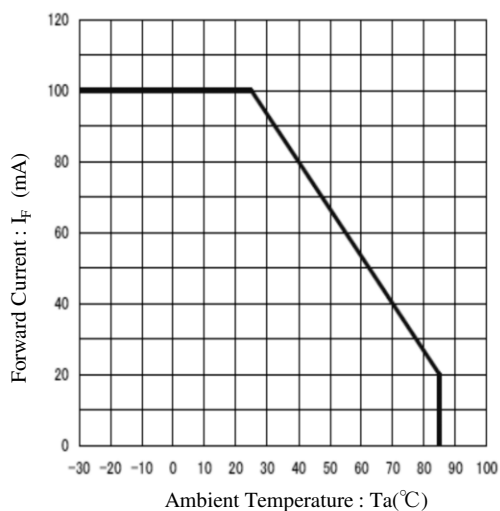


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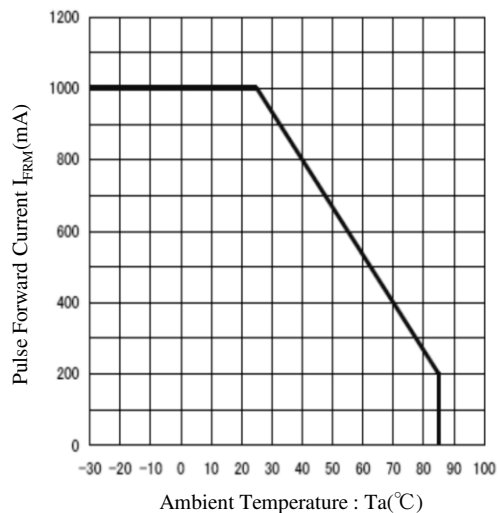


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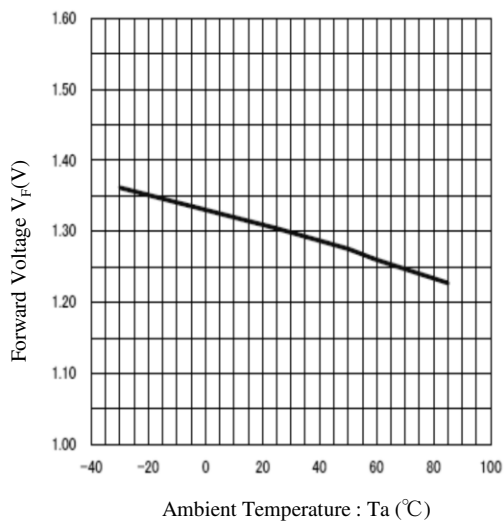
Ambient Temperature vs. Forward Current



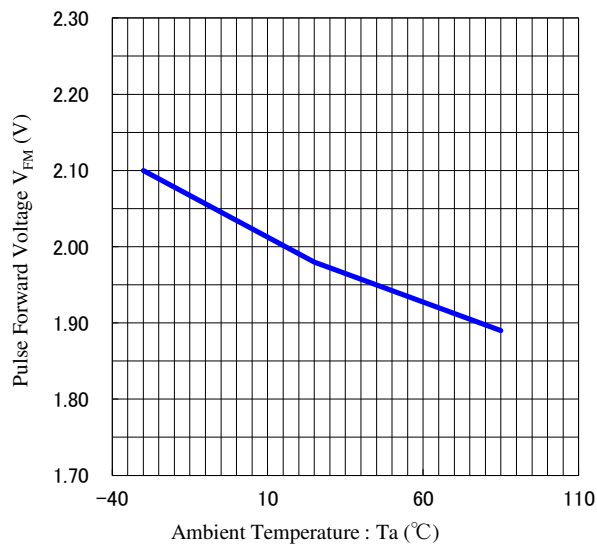
Pulse Forward Current vs. Ambient Temperature
Condition : $t_w \leq 100\mu s$, Duty $\leq 1/100$



Ambient Temperature vs. Forward Voltage
Condition : I_F = 50mA

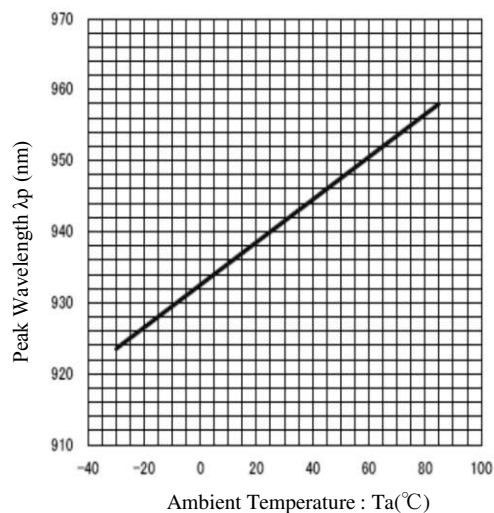


Ambient Temperature vs. Pulse Forward Voltage
Condition : I_{FRM} = 500mA, $t_w \leq 100\mu s$, Duty $\leq 1/100$

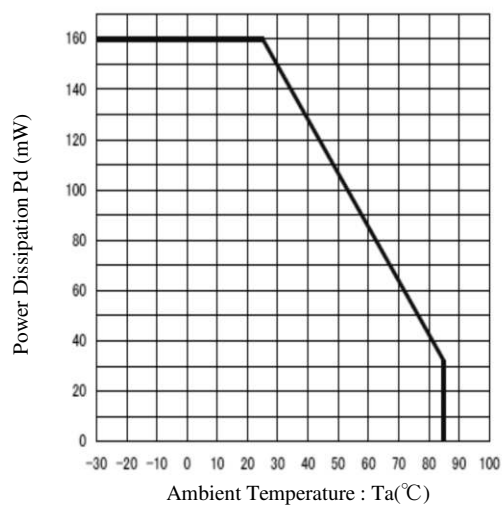


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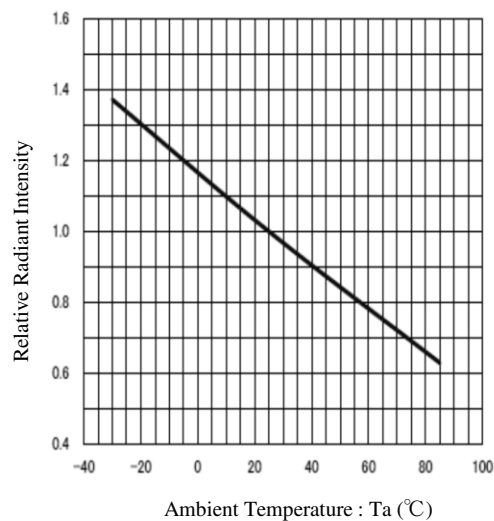
Ambient Temperature vs. Peak Wavelength
Condition : $I_f = 50\text{mA}$



Ambient Temperature vs. Power Dissipation

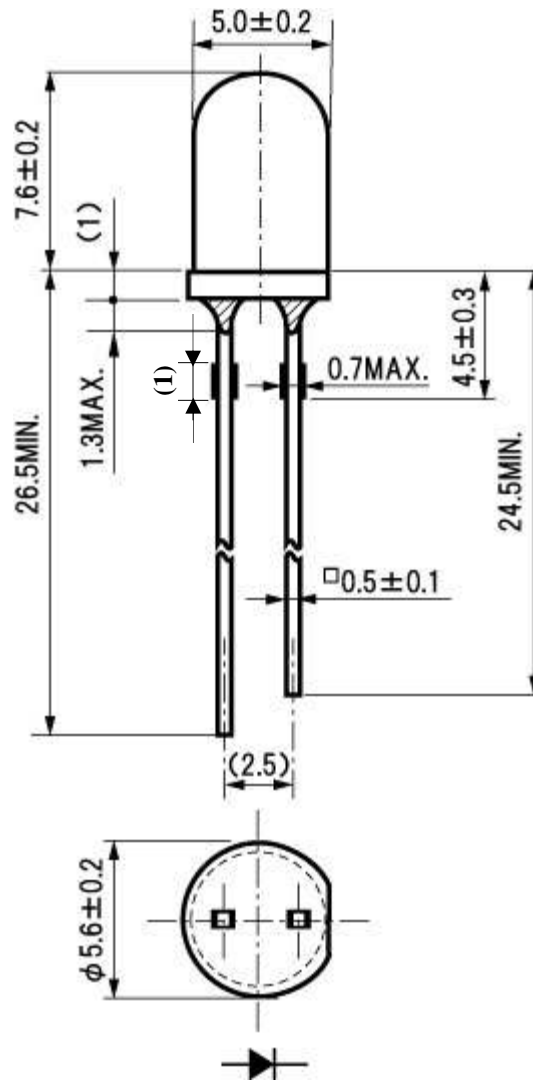


Ambient Temperature vs. Relative Radiant Intensity
Condition : $I_f = 50\text{mA}$



Package Dimensions

(Unit: mm)



TTW (Through The Wave) soldering Conditions

Pre-heating	100 °C	(MAX.) Resin surface temperature
Solder Bath Temp.	265 °C	(MAX.)
Dipping Time	5 s	(MAX.)
Position	At least 3.0 mm away from the root of lead	

- 1) The dip soldering process shall be twice maximum.
- 2) The product shall be cooled to normal temperature before the second dipping process.
 ※The detail is described to LED and Photodetector handling precautions of home page:
 "Mounting through-hole Type Devices" and "Soldering", and use it after the confirmation, please.

Manual Soldering Conditions

Iron tip temp.	400 °C	(MAX.) (30 W Max.)
Soldering time and frequency	3 s	(MAX.)
	1 time	(MAX.)
Position	At least 3.0 mm away from the root of lead	

- ※The detail is described to LED and Photodetector handling precautions of home page:
 "Mounting through-hole Type Devices" and "Soldering", and use it after the confirmation, please.

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, IF= Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(302)	265±5°C, 3mm from package base	10s	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~ Normal Temperature(15min) ~ Maximum Rated Storage Temperature(30min) ~ Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Lead Tension	EIAJ ED-4701/400(401)	10N, 1time (□0.4 and Flat Package : 5N)	10s	0/10
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	IF Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	VF	IF Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	IR	VR = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5

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